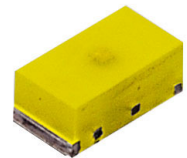
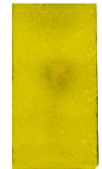


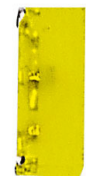
SpiceLED

Like spice, its diminutive size is a stark contrast to its standout performance in terms of brightness, durability and reliability. Despite being the smallest in size yet the SpiceLED packs a powerful performance and is a highly reliable design device. Its versatility enables its application in automotive appliances, key-pad illumination, hand-held devices such as PDAs, notebooks, compact back-lighting applications, consumer appliances, office equipment, audio and video equipment.



Features:

- > High brightness surface mount LED.
- > Super wide viewing angle of 160°.
- > Equivalent to 0603 package outline. Copper lead-frame construction.
- > Qualified according to JEDEC moisture sensitivity Level 2.
- > Compatible to IR reflow soldering.
- > Environmental friendly; RoHS compliance.
- > Superior Corrosion Resistant.



Applications:

- > Automotive: Interior applications, eg: switches, telematics, climate control system, dashboard, etc
- > Signage: full colour display video notice board, signage, special effect lighting.

Optical Characteristics at Tj=25°C

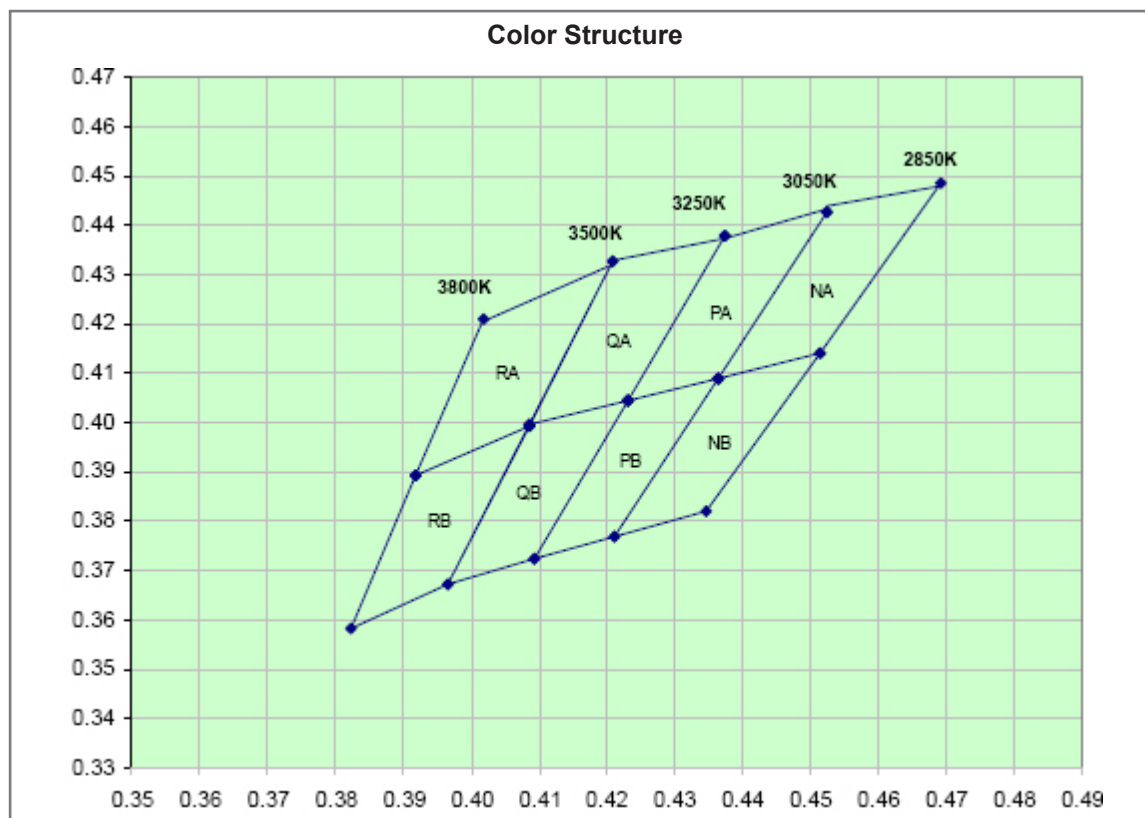
Part Ordering Number	Color	Viewing Angle°	Luminous Intensity @ IF = 20mA			IV (mcd) <i>Appx. 1.1</i>
			Min.	Typ.	Max.	
● SSF-LLG-T2U-1	Warm White	160	355.00	500.00	715.00	
● Not for new design.						

Part Number	Vf @ If = 20mA <i>Appx. 3.1</i>			Vr @ Ir = 10uA <i>Appx. 6.1</i>
	Min. (V)	Typ. (V)	Max. (V)	Min. (V)
SSF-LLG	2.9	3.2	3.6	5

Absolute Maximum Ratings

	Maximum Value	Unit
DC forward current	30	mA
Peak pulse current; (tp ≤ 10μs, Duty cycle = 0.1)	100	mA
Reverse voltage <i>Appx. 6.1</i>	5	V
ESD threshold (HBM)	2000	V
LED junction temperature	110	°C
Operating temperature	-40 ... +100	°C
Storage temperature	-40 ... +100	°C
Power dissipation (at room temperature)	80	mW
Thermal resistance		
- Junction / ambient, R _{th JA}	215	K/W
- Junction / solder point, R _{th JS}	125	K/W
(Mounted on FR4 PCB; pad size ≥ 16mm ² per pad)		

Wavelength Grouping *Appx. 2.1*



Bin		1	2	3	4
RA	Cx	0.402	0.392	0.409	0.421
	Cy	0.421	0.389	0.399	0.433
RB	Cx	0.392	0.382	0.397	0.409
	Cy	0.389	0.358	0.367	0.399
QA	Cx	0.421	0.409	0.423	0.437
	Cy	0.433	0.400	0.405	0.438
QB	Cx	0.409	0.397	0.409	0.423
	Cy	0.400	0.367	0.372	0.405
PA	Cx	0.437	0.423	0.436	0.452
	Cy	0.438	0.405	0.409	0.443
PB	Cx	0.423	0.409	0.421	0.436
	Cy	0.405	0.372	0.377	0.409
NA	Cx	0.452	0.436	0.451	0.469
	Cy	0.443	0.409	0.414	0.448
NB	Cx	0.436	0.421	0.435	0.451
	Cy	0.409	0.377	0.382	0.414

InGaN wavelength is very sensitive to drive current. Operating at lower current is not recommended and may yield unpredictable performance. Current pulsing should be used for dimming purposes.

Luminous Intensity Group at Tj=25°C

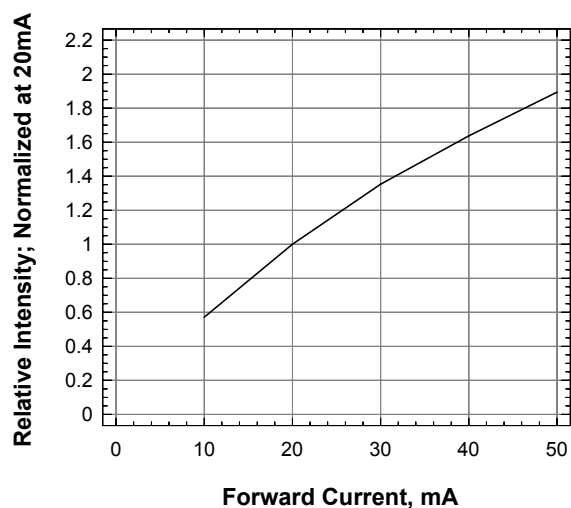
Brightness Group	Luminous Intensity <i>Appx. 1.1</i> IV (mcd)
T2	355.0 ... 450.0
U1	450.0 ... 560.0
U2	560.0 ... 715.0

Vf Binning (Optional)

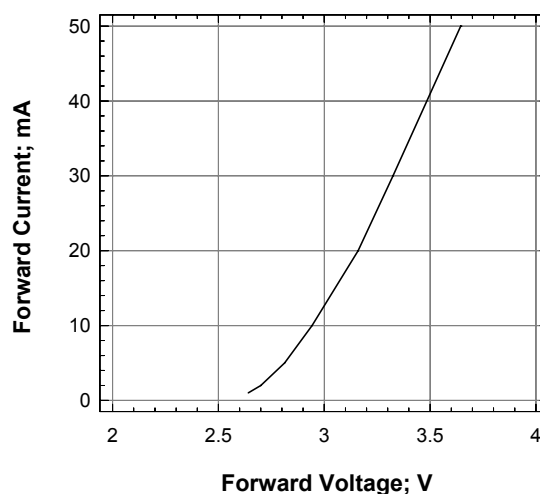
Vf Bin @ 20mA	Forward Voltage (V) <i>Appx. 3.1</i>
01	2.90 ... 3.00
02	3.00 ... 3.10
03	3.10 ... 3.20
04	3.20 ... 3.30
05	3.30 ... 3.40
06	3.40 ... 3.50
07	3.50 ... 3.60

Please consult sales and marketing for special part number to incorporate Vf binning.

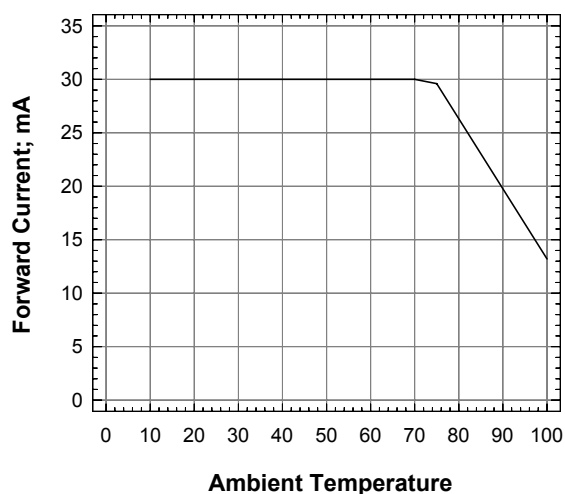
Relative Luminous Intensity Vs Forward Current



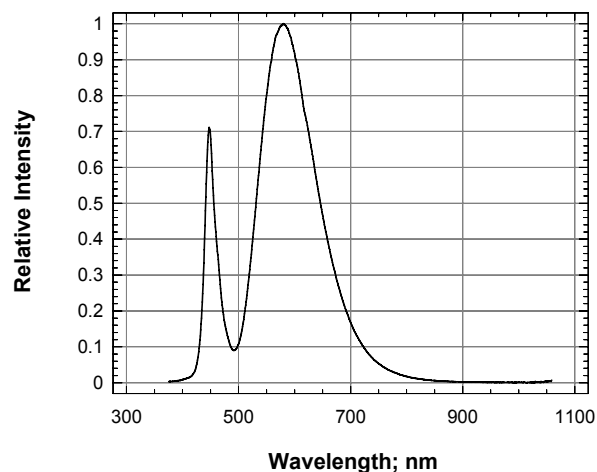
Forward Current Vs Forward Voltage



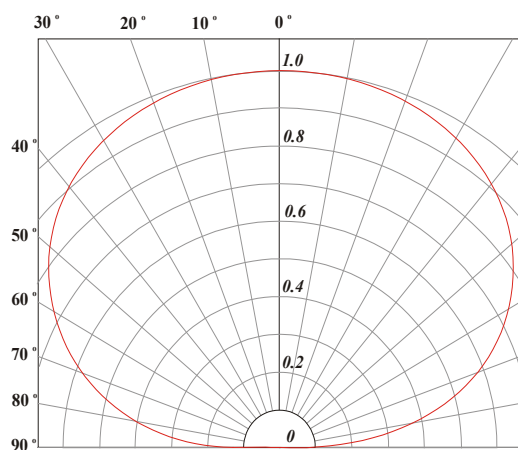
Forward Current Vs Ambient Temperature



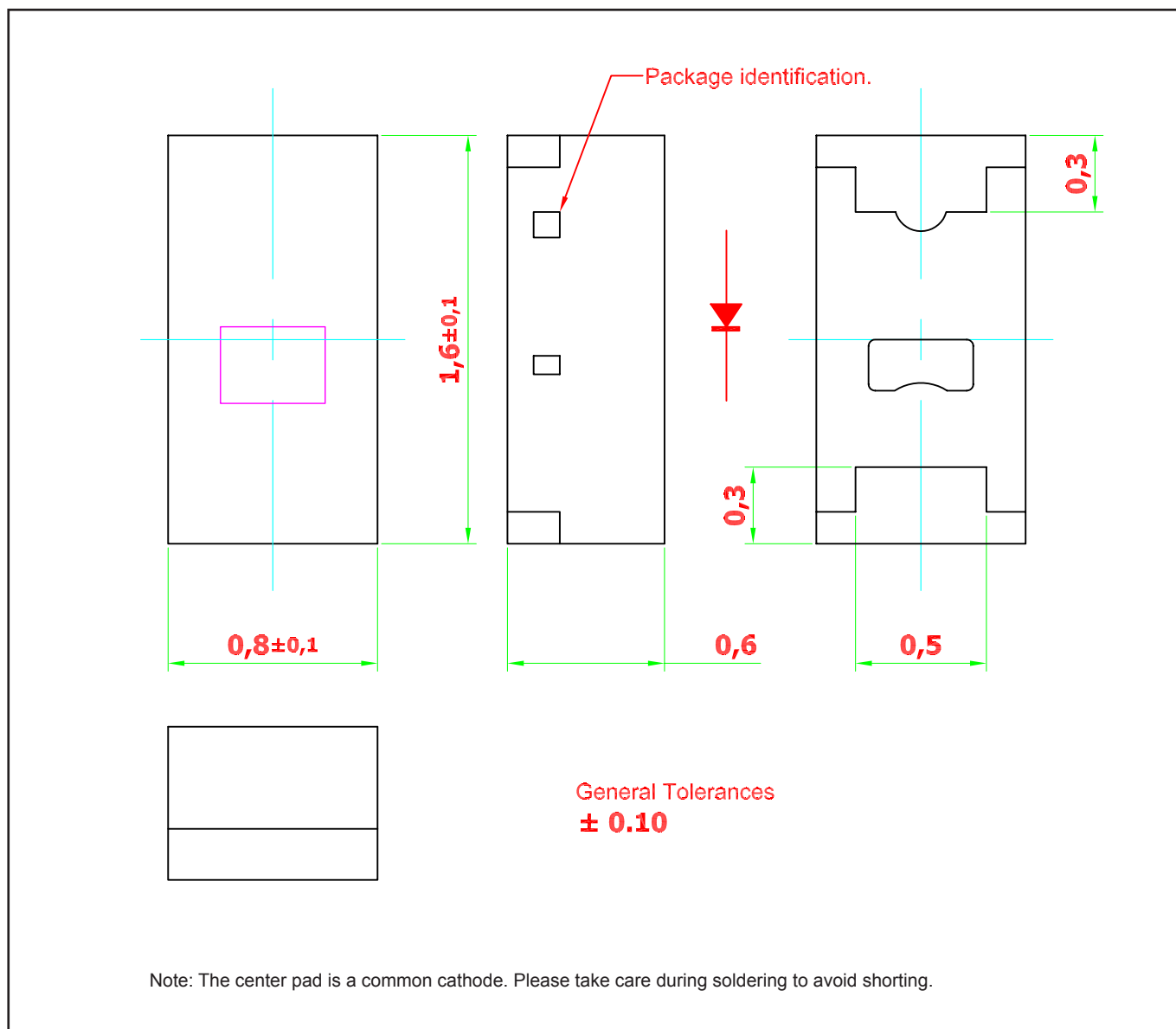
Relative Intensity Vs Wavelength



Radiation Pattern



SpiceLED • InGaN : SSF-LLG Package Outlines

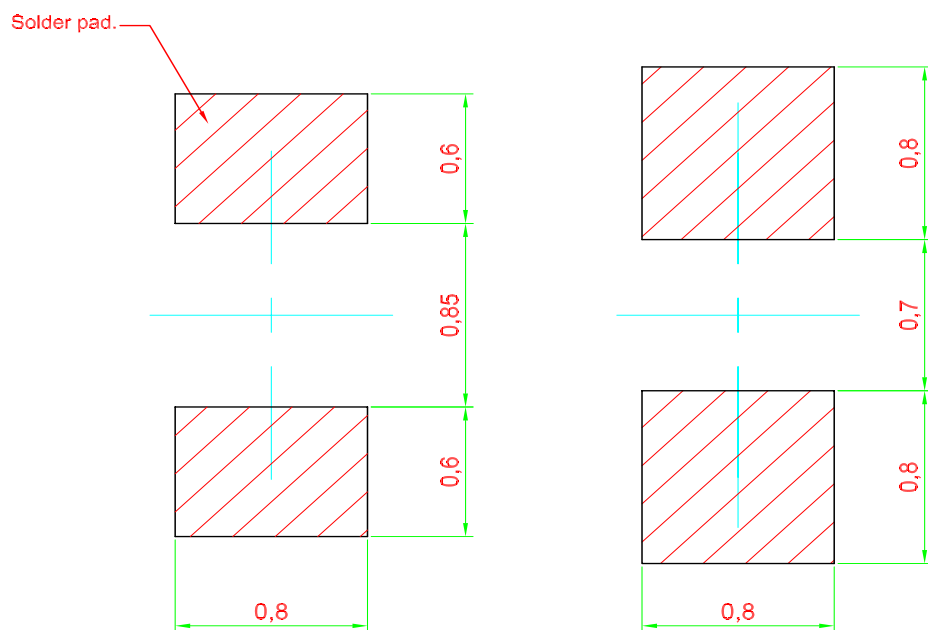


Material

Material	
Lead-frame	Cu Alloy With NiPdAu Plating
Package	High Temperature Resistant Epoxy Resin

Note: product is Pb free

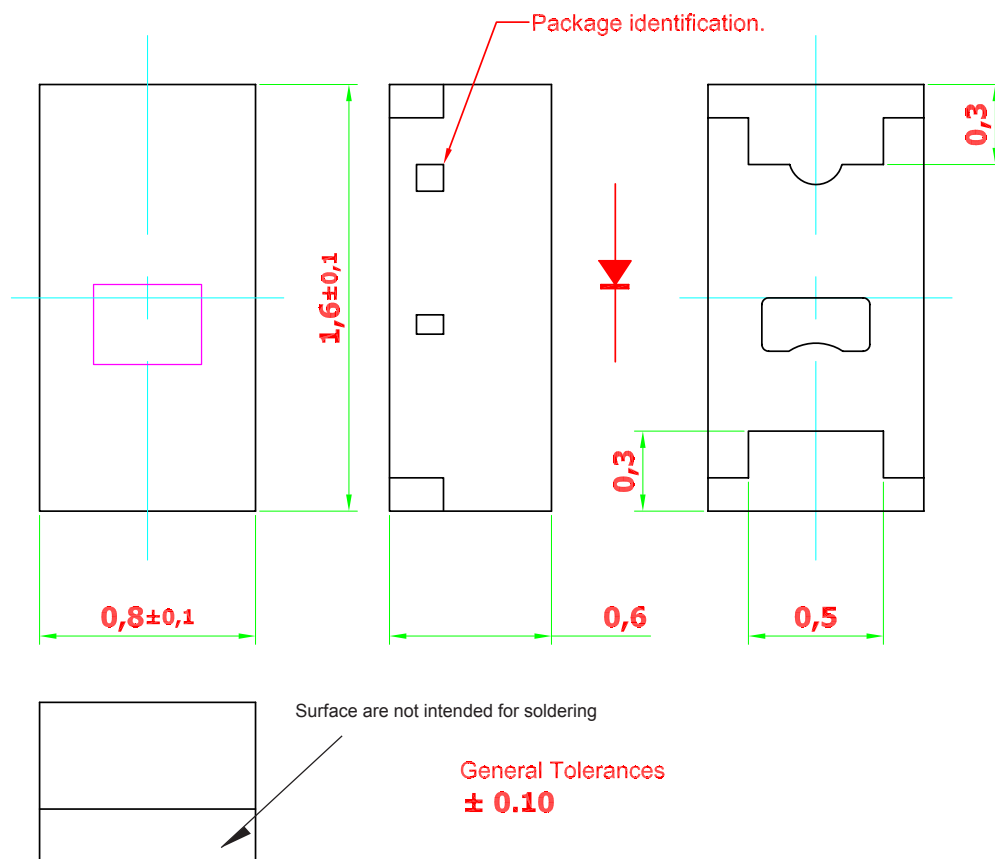
Recommended Solder Pad



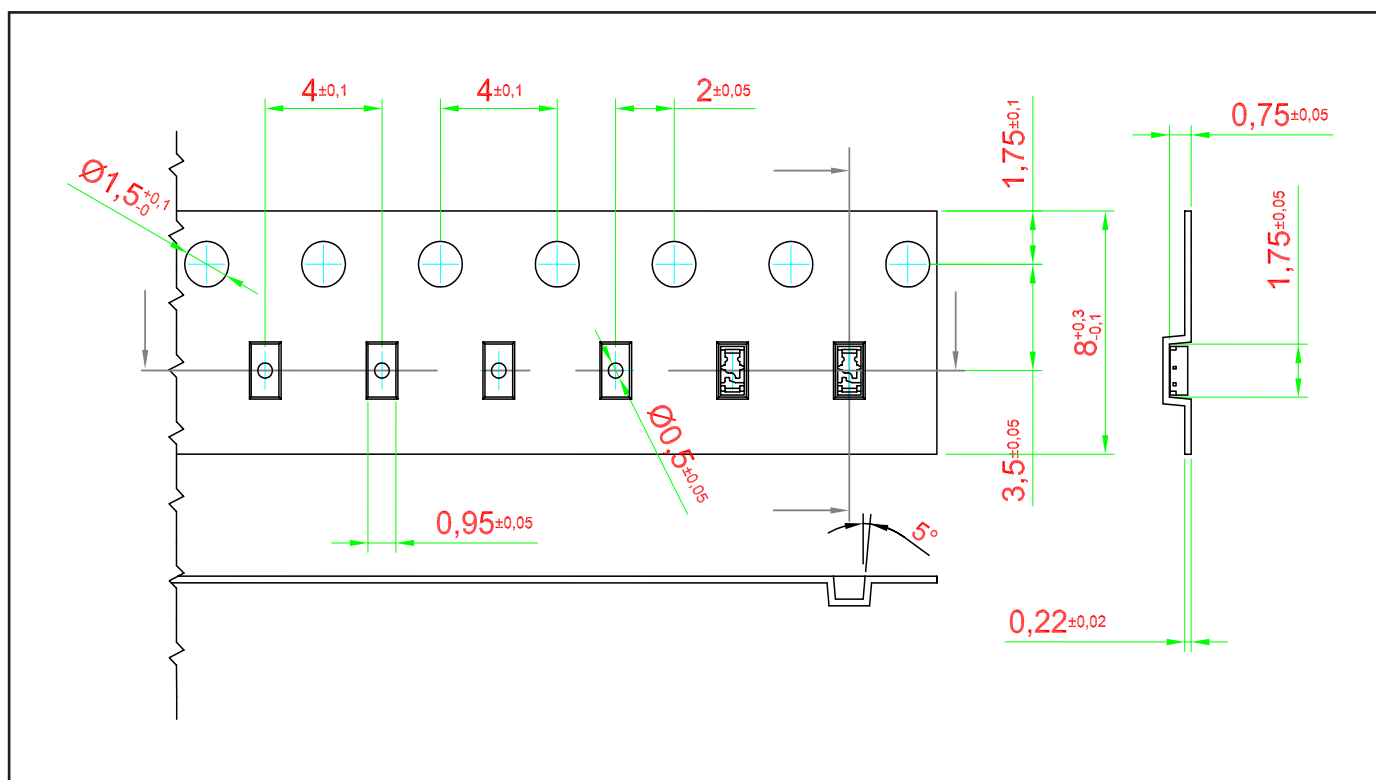
Recommended Solder-pad

Alternative Solder-pad
 Compatible to ChipLED 0603

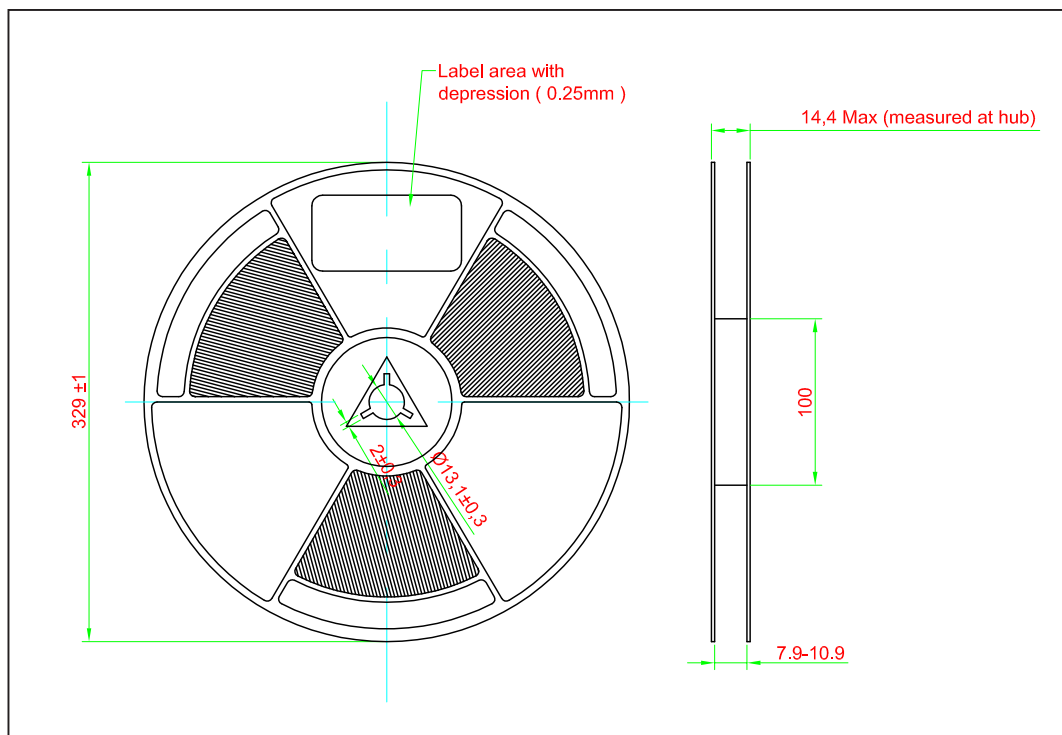
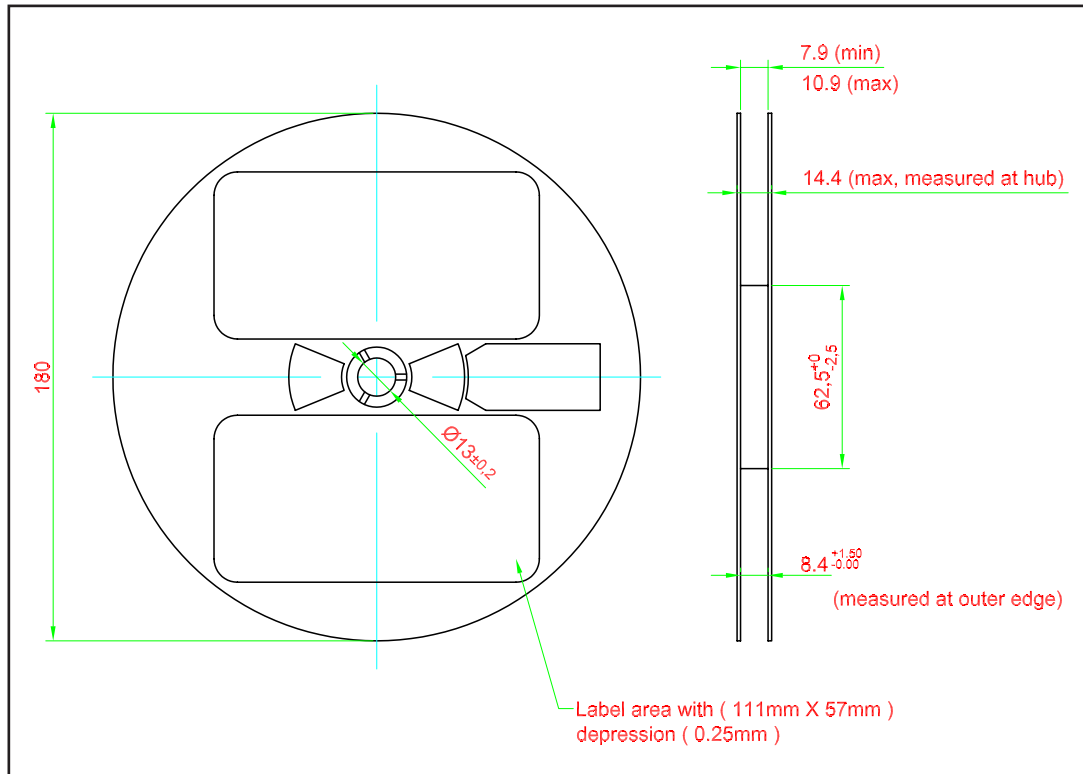
Note: Component is based on a new package platform, which features "Bottom Only Terminations". Solder joints are only formed at the bottom of the component and solder fillet will not be observable as the sides of the component.



Taping and orientation

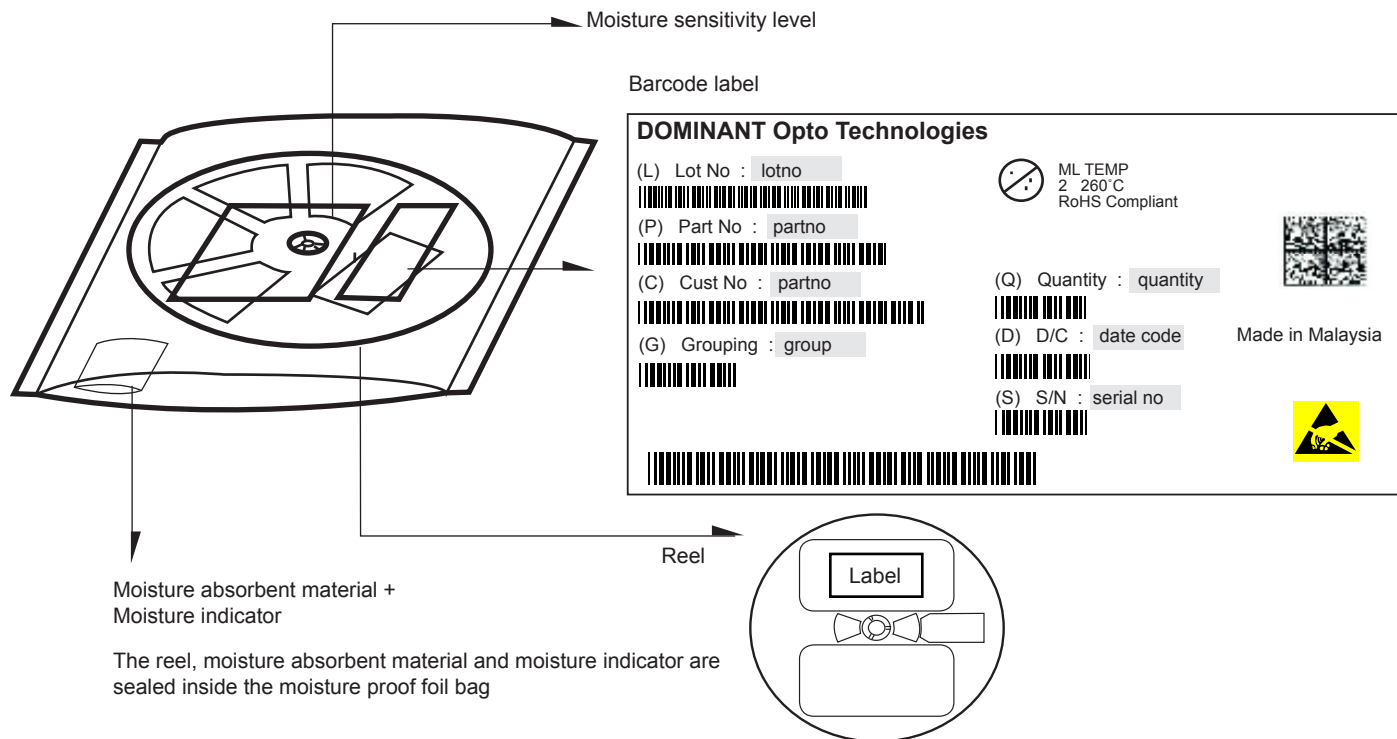


Packaging Specification

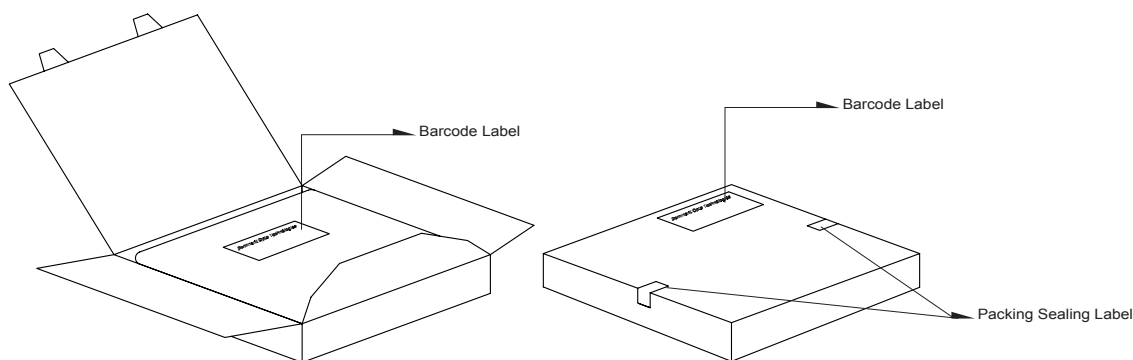


	Reel Diameter (mm)	Quantity (pcs)	Partno
Standard Packing	180	3000	SSF-LLG-XXX-X
Optional Packing	329	18000	SSF-LLG-XXX-X-M

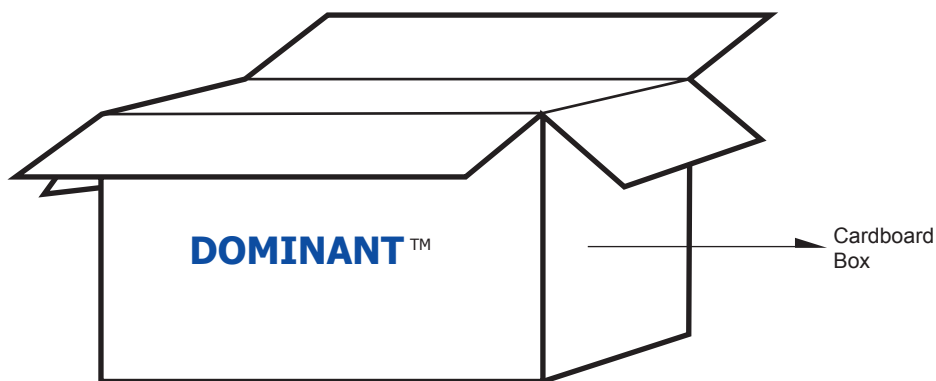
Packaging Specification



Quantity per bag (pcs)	Average 1pc SpiceLED (gram)	1 completed bag (gram)
3000	0.001	140 ± 10
18000	0.001	470 ± 10

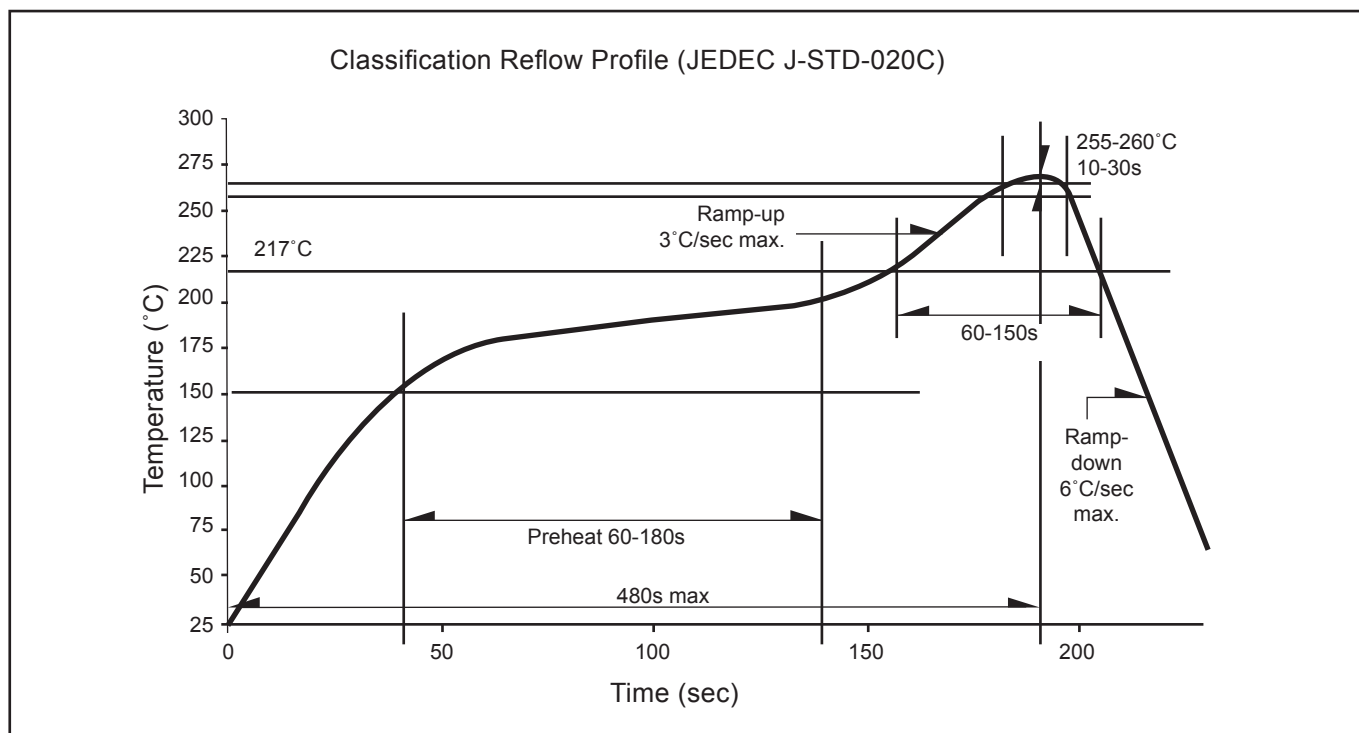


Reel Diameter (mm)	Packing Box Dimensions (mm)
180	210 x 210 x 16
329	345 x 345 x 16



Reel Diameter (mm)	Cardboard Box Size	Dimensions (mm)	Empty Box Weight (kg)	Reel / Box
180	Super Small	325 x 225 x 190	0.38	9 reels MAX
180	Small	325 x 225 x 280	0.54	15 reels MAX
180	Medium	570 x 440 x 230	1.46	60 reels MAX
180	Large	570 x 440 x 460	1.92	120 reels MAX
329	Medium	373 x 373 x 285	1.02	13 reels MAX
329	Large	580 x 373 x 405	1.50	30 reels MAX

Recommended Pb-free Soldering Profile



Appendix

1) **Brightness:**

- 1.1 Luminous intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.2 Luminous flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.3 Radiant intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.4 Radiant flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).

2) **Color:**

- 2.1 Chromaticity coordinate groups are measured at current pulse 25 ms(typ) with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (accordingly to GUM with a coverage factor of $k=3$).
- 2.2 Dominant wavelength is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 0.5\text{nm}$ and an expanded uncertainty of $\pm 1\text{nm}$ (accordingly to GUM with a coverage factor of $k=3$).

3) **Voltage:**

- 3.1 Forward Voltage, V_f is measured when a current pulse of 8 ms(typ) with an internal reproducibility of $\pm 0.05\text{V}$ and an expanded uncertainty of $\pm 0.1\text{V}$ (accordingly to GUM with a coverage factor of $k=3$).

4) **Typical Values:**

- 4.1 At special conditions of LED manufacturing processes, typical data or calculated correlations of technical parameters only reflect the statistical figures. But not necessarily correspond to the actual parameters of each single product, which could differ from the typical data or calculated correlations or the typical characteristic line. These typical data may change whenever technical improvements happen.

5) **Tolerance of Measure**

- 5.1 Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimension are specified in mm.

6) **Reverse Voltage:**

- 6.1 Not designed for reverse operation. Continuous reverse voltage can cause migration and LED damage.

Revision History

Page	Subjects	Date of Modification
-	Initial release	29 Oct 2013
8	Update Carrier Tape	13 Feb 2014
1, 8, 10, 12	Error on Taping and Orientation Update Packaging Specification Add Appendix	03 Nov 2016
2, 9, 10, 11, 12	Not for New Design: SSF-LLG-T2U-1 Update Package Specification Update Appendix	11 Aug 2020

NOTE

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DOMINANT Opto Technologies is a dynamic company that is amongst the world's leading automotive LED manufacturers. With an extensive industry experience and relentless pursuit of innovation, DOMINANT's state-of-art manufacturing and development capabilities have become a trusted and reliable brand across the globe. More information about DOMINANT Opto Technologies, an IATF 16949 and ISO 14001 certified company, can be found under <http://www.dominant-semi.com>.

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